CLAIMS

What is claimed is:

1. An implantable lead for use with electrical stimulation, the lead comprising:

a flexible carrier having a proximal end, a distal end, a medial side and a lateral side;

a distal, pre-curved lead section having memory;

a plurality of electrode contacts embedded at the distal end of the lead, which electrode contacts comprise an electrode array;

a plurality of conductor wires embedded in the carrier, each conductor wire connected to at least one electrode contact; and

a longitudinal stylet insertion channel in the carrier extending into at least a part of the distal, pre-curved lead section.

- 2. The lead of claim 1, wherein the electrode contacts and connected conductor wires are pre-bent to a desired pre-curvature before the flexible carrier is molded over the electrode contacts and conductor wires.
 - 3. The lead of claim 1,

wherein the distal, pre-curved lead section is dimensionally pre-curved to conform to about one spiral turn in a human cochlear duct; and wherein the distal, pre-curved lead section has a curvature, taper and size to provide medial contact with the cochlear duct.

4. The lead of claim 1,

wherein the lead has a distal part that is substantially hooked shaped and has a spiral curvature dimensioned to conform to a human cochlear duct and also to provide lateral contact with this cochlear duct; and

wherein the distal, pre-curved lead section is dimensionally tapered and sized so that the electrode array can be implanted to exceed about 1 turn inside the cochlear duct.

5. The lead of claim 4, wherein the distal lead is dimensionally tapered and sized so that the lead can be implanted no greater than about 2 turns inside the cochlear duct, which duct is the scala tympani.

6. The lead of claim 4,

wherein the most distal tip of the lead that includes a subset of the electrode array is constructed as a super-flexible tip; and

wherein the super-flexible tip does not include the stylet insertion channel and which super-flexible tip has a substantially smaller thickness than the remainder of the distal lead containing the electrode array that is not super-flexible.

- 7. The lead of claim 1, wherein the conductor wires are zigzagged conductor wires.
- 8. The lead of claim 1, further comprising an overmold which caps the opening of the stylet channel and wherein the overmold has a slit opening.
- 9. The lead of claim 8, wherein the overmold has a cross-configured slit for allowing an insertion stylet to be inserted into the stylet insertion channel.

10. The lead of claim 8, further comprising:a pin plug which has a head and a curved tail pin, which pin plug isdimensioned and configured to permit the pin plug to be inserted head first into

11. The lead of claim 8, further comprising: a malleable ring in the lead carrier encircling the slit in the overmold, which malleable ring can be crushed around the slit to provide a

the overmold slit opening to seal the slit opening.

compressive seal to the slit.

- 12. The lead of claim 1, wherein at least part of the stylet insertion channel is formed by incorporating a tube into the lead, wherein the tube is made from a different material than the carrier.
 - 13. The lead of claim 12, wherein the tube is a Teflon (PTFE) tube.
 - 14. A method of manufacturing an implantable stimulating lead comprising:
- (a) attaching a plurality of inert electrode contacts onto chemically dissolvable strip substrate having a first, distal end and a second, proximal end;
- (b) coupling each electrode contact to a conductor wire to create an electrode array assembly;
- (c) attaching the first, distal end of substrate to a revolving dowel, which dowel is integrated into a mold having a cavity, the dowel placed inside the cavity;
- (d) attaching the proximal, second end of the substrate to a restraint which applies tension to the electrode array assembly;
- (e) turning the dowel to create a predetermined curvature on the distal end of the electrode array assembly;

- (f) delivering a body-compatible carrier material into the cavity and around the electrode array assembly to create a carrier/covering;
 - (g) releasing the formed lead from the mold; and
- (h) applying a weak acid and heat to the chemically active substrate to dissolve away the substrate and expose the inert, electrode contact on the surface of the lead.
 - 15. The method of claim 14, further comprising: between the step (e) and (f),
- (e1) placing a mandrel into the cavity, oriented approximately parallel to the electrode array assembly, wherein one end of the mandrel is situated to escape coverage by injected carrier material; and and after the step (q),
- (g1) pulling the mandrel out of the carrier to create a stylet insertion channel with a channel opening on the lead.
 - 16. The method of claim 15, further comprising the step:
- (i) attaching an overmold over the opening of the stylet insertion channel, which overmold has a slit opening.
 - 17. The method of claim 14, further comprising: between the step (e) and (f),
- (e1) placing a mandrel inside the lumen of a thin-walled Teflon tubing;
- (e2) placing the combination of the Teflon tubing with the inserted mandrel inside the tubing into the mold cavity, the combination oriented approximately parallel to the electrode array assembly, wherein one end of the mandrel is situated to escape coverage by the delivered carrier material; and and after the step (g),

- (g1) pulling the mandrel out of the Teflon tubing to create the stylet insertion channel.
 - 18. The method of claim 17, wherein the mandrel is made of Teflon.
 - 19. The method of claim 17, further comprising the step:
- (i) attaching an overmold over an opening of the stylet insertion channel, which overmold has a slit opening.
- 20. A method of implanting an implantable stimulation lead having an insertion stylet channel with a channel opening on the lead body, the method comprising:
 - (a) implanting the lead using the stylet;
 - (b) withdrawing the stylet from the lead; and
 - (c) capping the insertion stylet channel opening.
- 21. The method of claim 20, wherein capping the channel opening is accomplished by taking a pin plug, having a head and curved pin, and inserting the head of the pin plug into the lead to seal the channel opening.
- 22. The method of claim 20, wherein capping the channel opening is accomplished by providing a malleable ring in the lead body which encircles the channel opening and crushing the ring to seal the channel opening.
 - 23. A cochlear lead system comprising:
 - a cochlear lead including:
 - a flexible carrier having a proximal end and distal end;
 - a stylet insertion channel incorporated into the flexible

carrier; and

an electrode array placed on the distal lead end;
a pin plug for capping the insertion stylet, the pin plug having a
head and tail pin with a curvature in the tail pin; and

an insertion tool which has a first end and second end, wherein the first end has a pin plug holding channel that accommodates the tail pin and holds it within the holding channel with a friction fit.